

(0.80 mm) .0315" PITCH • MICRO TIGER EYE™ HEADER

TEM



NO. OF POSITIONS



DH1

PLATING OPTION



OPTION

10, 15, 20, 25, 30, 35, 40, 45, 50 (Per Row) (Standard sizes)

= Gold Flash on contact, Matte Tin on tail

= 10 μ" (0.25 μm) Gold on

contact, Matte Tin on tail

= 30 μ" (0.76 μm) Gold on contact, Matte Tin on tail

-A = Alignment Pin

TEM-DH **Board Mates:**

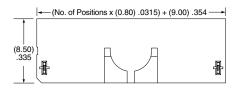
SEM. SEML

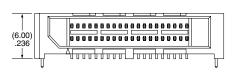
SPECIFICATIONS

Insulator Material: Black Liquid Crystal Polymer **Terminal Material:** Phosphor Bronze Plating: Au or Sn over 50 μ" (1.27 μm) Ni Current Rating: 2.9 A per pin (2 pins powered) Voltage Rating: 235 VAC/330 VDC **Operating Temp Range:** °C to +125 °C

PROCESSING

Lead-Free Solderable: SMT Lead Coplanarity: (0.10 mm) .004" max.









View complete specifications at: samtec.com?TEM

TEM



POSITIONS PER ROW

05, 10, 15, 20

(Standard sizes)

02

03.0

PLATING OPTION

-G

D

L1

_11

= Latching

OPTIONS

-K

= (5.50 mm) .217" DIA

Polyimide film Pick & Place Pad

-TR = Tape & Reel

-FR

= Full Reel

Tape & Reel (must order max.

quantity per reel; contact Samtec

for quantity

breaks)

TEM-L1

Cable Mates:

SPECIFICATIONS

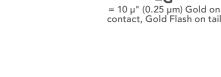
Insulator Material: Natural Liquid Crystal Polymer **Terminal Material:** Phosphor Bronze Phosphor Bronze
Plating:
Au over 50 μ" (1.27 μm) Ni
Current Rating:
1.9 A per pin (2 pins powered)
Voltage Rating:
235 VAC/330 VDC
Operating Temp Range:
-55 °C to +125 °C

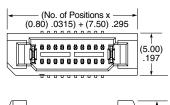
PROCESSING

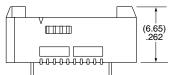
Lead-Free Solderable: SMT Lead Coplanarity: (0.10 mm) .004" max.

Note:

Some lengths, styles and non-returnable







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